INFORMATION D	SCLOSURE
STATEMENT BY	APPLICANT
( Not for submission und	der 37 CFR 1.99)

Application Number		10581634
Filing Date		2007-02-26
First Named Inventor	Okahi	isa
Art Unit		3788
Examiner Name	Desa	KA.
Attamen Dealest Numb		1001 0003010110

Examiner Initial*	Cite No	Patent Number	Kind Code <sup>1</sup>	Issue D	ate	Name of Pate of cited Docu	entee or Applicant ment	Relev	ges,Columns,Lines where levant Passages or Relevant jures Appear			
	1											
If you wis	h to ad	d additional U.S. Pater	nt citatio	n informa	ation pl	lease click the	Add button.		Add		$\neg$	
			U.S.P	ATENT /	APPLI	CATION PUB	LICATIONS		Remove			
Examiner Initial*	Cite N	Publication Number	Kind Code <sup>1</sup>	Publicat Date	ion	Name of Pate of cited Docu	entee or Applicant ment	Relev	Pages,Columns,Lines where Relevant Passages or Relev Figures Appear			
	1								Add			
If you wis	h to ad	ld additional U.S. Publi		,		n information p		d buttor	Remove		$\dashv$	
Examiner Initial*	Cite No	Foreign Document Number <sup>3</sup>	Country Code <sup>2</sup>	,	Kind Code <sup>4</sup>	Publication	Name of Patente Applicant of cited Document	Pages, Columns, Lines where Relevant Passages or Relevan Figures Appear				
	1	2004141631	JP			2004-05-20	Fuso Pharmaceutical Industries LTD					
	2	03-099668	JP			1991-04-24	TERUMO CORP					
	3	10-005313	JP	р		1998-01-13	MATERIAL ENG TECH LAB INC					

U.S. PATENTS

## INFORMATION DISCLOSURE STATEMENT BY APPLICANT (Not for submission under 37 CFR 1.99)

Application Number		10581634					
Filing Date		2007-02-26					
First Named Inventor	Okahi	kahisa					
Art Unit		3788					
Examiner Name	Desa	, KA.					
Attament Dealest Number		1091 0003WOLIG					

If you wish	h to a	dd addit	tional For	eign Pate	nt Docur	ment o	citation	inform	tion plea	se click t	the Add b	uttor	Ad	d			
					NON-P	ATEN	NT LITE	RATU	RE DOCU	MENTS			Rem	ove			
Examiner Initials*	Cite No	(book,	nclude name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item book, magazine, journal, serial, symposium, catalog, etc), date, pages(s), volume-issue number(s), ubdisher, city andor country where published.										Τs				
	1	Japane	ese Notice	of Reason	s for Rejo	ection	for Japa	nese P	itent Appli	cation No	. 2004-222	2095					
	2	Japane	ese Notice of Ressons for Rejection of Japanese Patent Application No. 2004-222090														
If you wis	h to a	dd addit	tional non	-patent li	erature	docun	ment cit	ation in	formation	please	click the A	Add b	utton	Ad	d		
						EX	AMINE	R SIGN	ATURE								
Examiner Signature Date Considered																	
*EXAMIN citation if																gh a	

See Not Octobe of USPTO Planto Documents at your USPTO, DOLY or MPEP 901.04. \* Enter office an all issued for document, by the ho-letter code (WIPO Standard ST3.). \*\*To Apparese parted convenients, the adulation of the year of the reign or the Engineer must proceed the serial number of the parted toodument. \*\*A find of Cocument by the appropriate symbol as a indicated on the document under WIPO Standard ST, 16 if possible. \*\*Applicant is to place a check mark here (Engine) language arrangements are standard.